

**SDU Microelectronics**

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**ICELab**

Research and Chip Courses at SDU

14 APRIL 2026 · DTU LYNGBY

SDU 

**DTU Chipday 2026**

# SDU Micro | ICELab | Sub-Groups



## Biomedical IC Design

Integrated circuits for medical diagnostics, monitoring, and therapeutic devices.

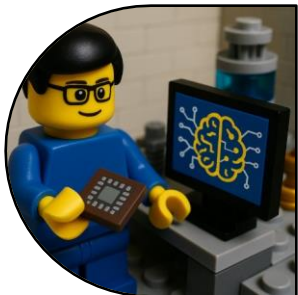
- Low-power and wearable biosensors
- Implantable and minimally invasive devices
- Analog front-ends for bio-signal acquisition



## Cryogenic CMOS

Low-temperature circuit design for quantum systems and ultra-low-noise applications.

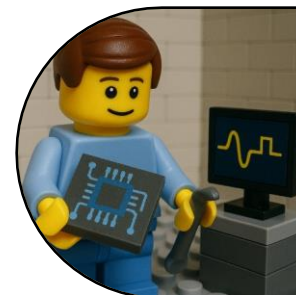
- Operation at 4 K and below
- Readout/control circuits for quantum processors
- Device modeling under cryogenic conditions



## Advanced Computing

Neuromorphic, spintronic, and beyond-CMOS computing.

- Neuromorphic computing for data, image, and video processing (Robotics, Drones, etc.)
- In-memory and non-Von Neumann paradigms
- Electronics, Spintronics, and Photonics challenges
- Large language Models on ASIC



## Analog Mixed-Signal IC Design

Bridging analog precision with digital flexibility in modern electronic systems.

- High-Precision sensor interfaces for industry
- Low-Power Data converters (ADC/DAC)
- Design trade-offs: speed, accuracy, and power



## Power Management IC Design

Enabling intelligent energy control in microelectronic systems through compact, efficient power solutions.

- Ultra-low power DC-DC converters for embedded and IoT platforms
- For Automotive and Space Applications
- High-efficiency and small form-factor solutions
- Battery Health Monitoring



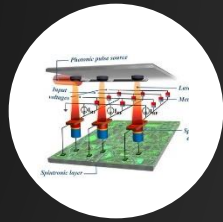
## Chip for Space and Security

Design and Implementation of secure and space-grade chips for sensing, processing, and power management.

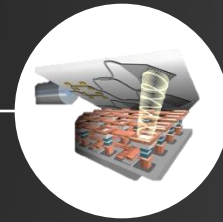
- Hardware Security
- Radiation Hardened, the ability to operate in harsh environments

# ICELab Projects

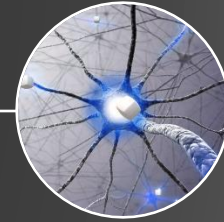
## Past and Current



NeuroCoM  
€0.24 Million



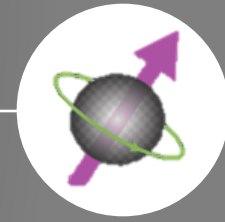
SPICE  
€3.4 Million



STARDUST  
€3.8 Million



HERMES  
€8.43 Million



SHADE  
€0.2 Million



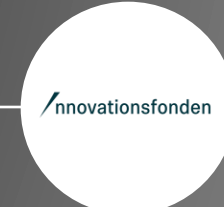
Corrosense  
DKK 26 Million



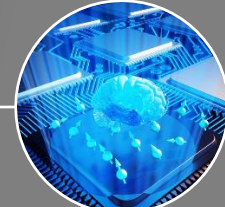
SpinGrain  
€2 Million



PipeSense  
€2 Million



DigiMon  
€0.2 Million



SPINAGE  
€4.38 Million



iSKIN BIO-X  
DKK 4 Million



Neuro-Sense  
DKK 2.2 Million



SWAN ON CHIP  
€3.2 Million



DONUT  
€2.6 Million



EPIFY  
DKK 23 Million



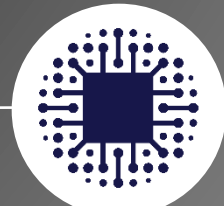
SPINCHIP  
€ 9 Million



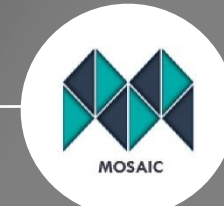
ODE4EC\_AMS  
€ 12 Million



NeuroEar  
DKK 3.2 Million



DkCCC  
€7.7 Million



MOSAIC  
€53 Million



NeuroMate  
DKK 31 Million

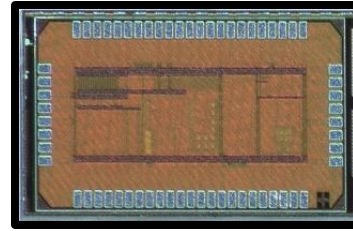
# ICELab Selected Projects

## PipeSense

To develop a novel leakage sensing mechanism for precise water leak detection in underground pipes.

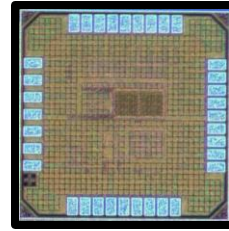
### Analog and Digital Time Domain Reflectometry (TDR) Chip

65nm CMOS  
7-bit Current DAC  
1.3ns Time Error  
0.18m Dist. Error  
7.5mW A-Power  
1.47mW D-Power



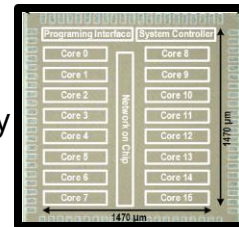
### A Fully CMOS Low-Power Temperature Sensor

65nm CMOS  
-20°C to +120°C  
±1.36°C 3σ Inacc.  
0.019 nJK<sup>2</sup> FoM



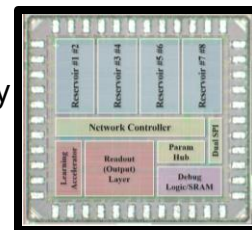
### Digital SNN (AI) NEXUS

28nm CMOS  
16-Core FC SNN  
LI/LIF Neurons  
300MHz Frequency  
0.55V Supply  
1.54mW Power



### Digital SNN (AI) SPIRE

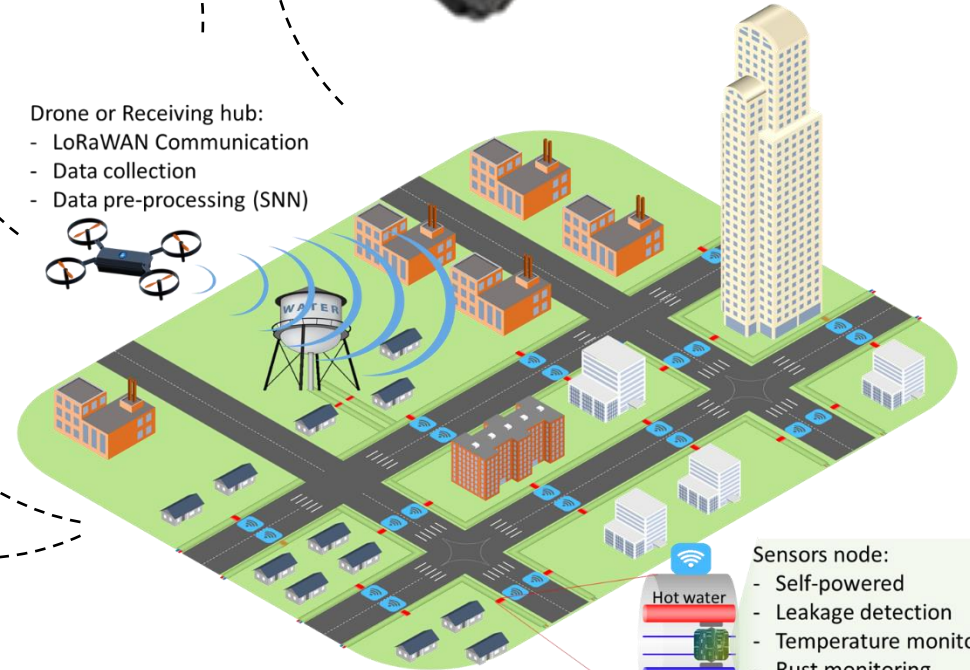
28nm CMOS  
On-chip learning  
400MHz Frequency  
10pJ/SOP  
0.9V Supply



### PipeSense Sensor Box

TDR Sensor Chip  
Temp. Sensor Chip  
Honeywell Sensors  
Thermistors (x4)  
TEG Energy-Harv.  
Power Manag. Unit  
1 F Super-Capacitor  
ARM Microcontroller  
LoRa Module  
LoRa Antenna

Drone or Receiving hub:  
- LoRaWAN Communication  
- Data collection  
- Data pre-processing (SNN)



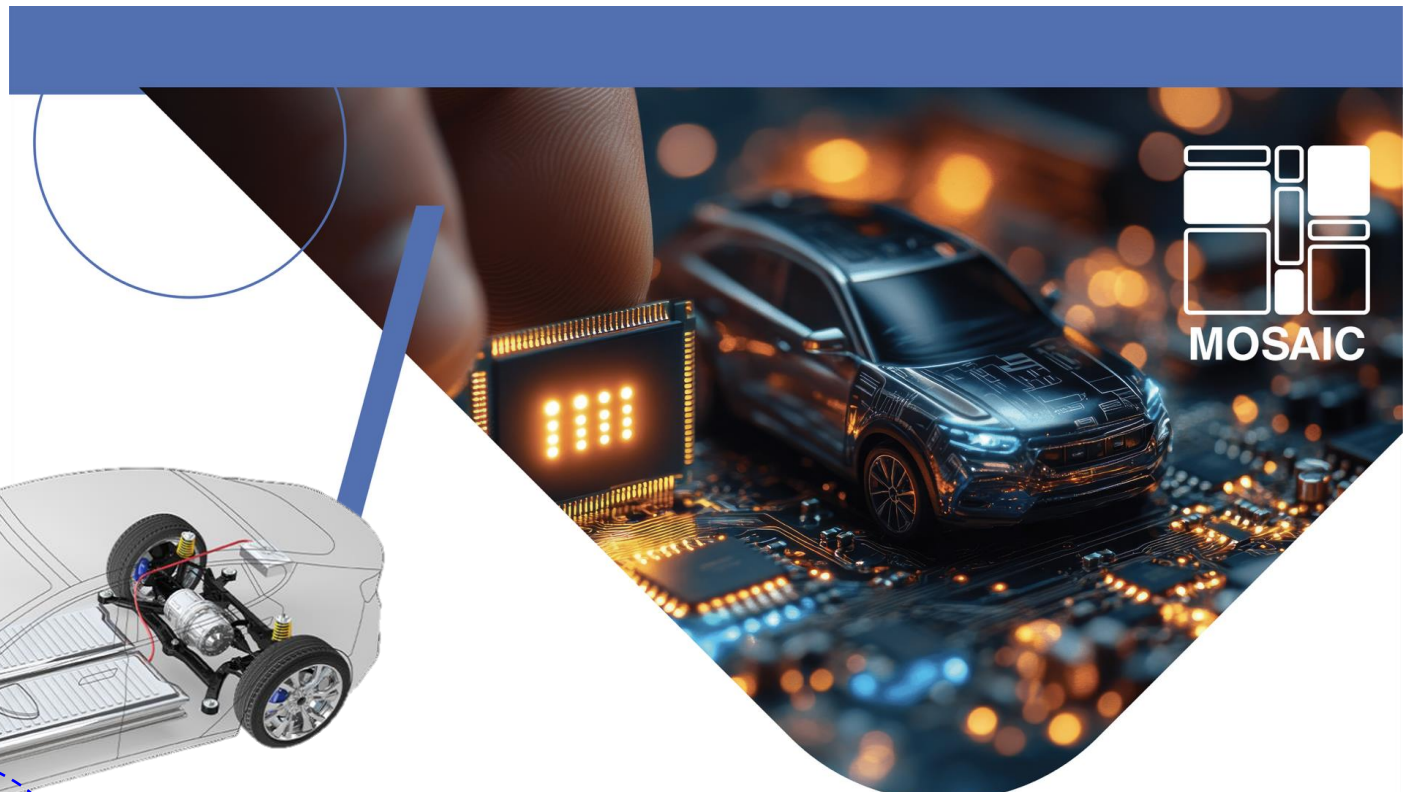
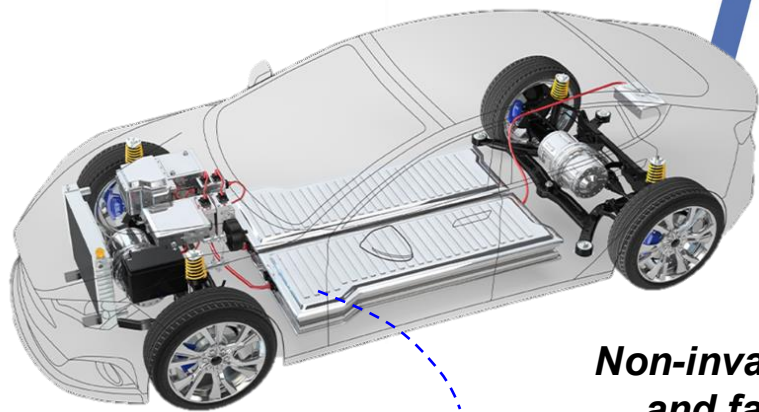
Sensors node:  
- Self-powered  
- Leakage detection  
- Temperature monitor  
- Rust monitoring  
- On-chip processing  
- LoRaWAN Communication



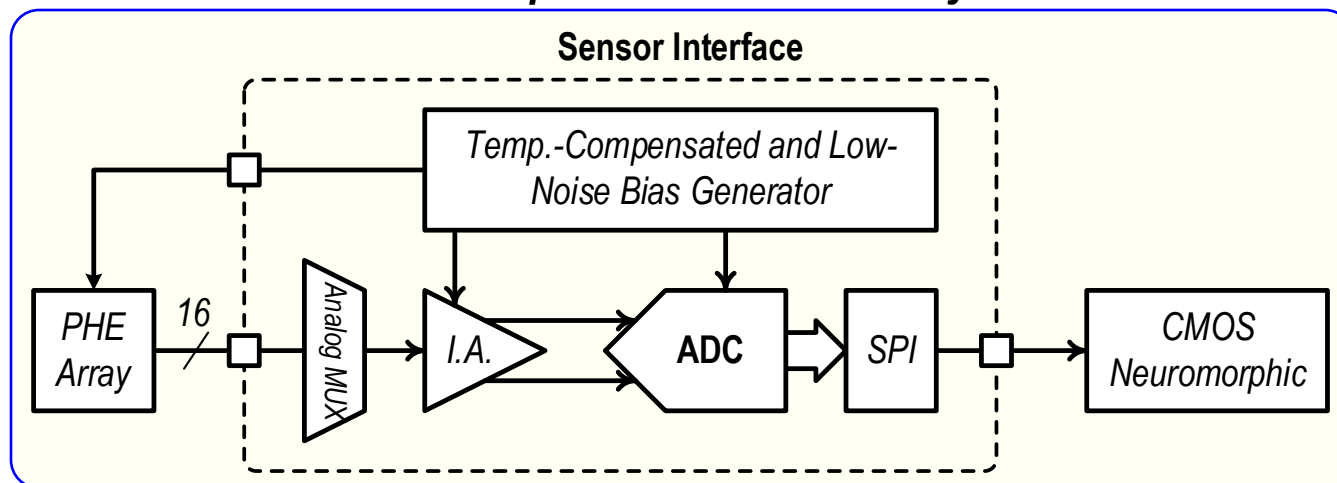
# ICELab Selected Projects

## MOSAIC

**MOSAIC** addresses a grand challenge for European competitiveness: technological independence and filled fabs in the landscape of automated systems. By fostering innovation in Electronic Components and Systems (ECS), **MOSAIC** aims to propel Europe to excellence and digital autonomy, directly linked to the EU Chips Act.



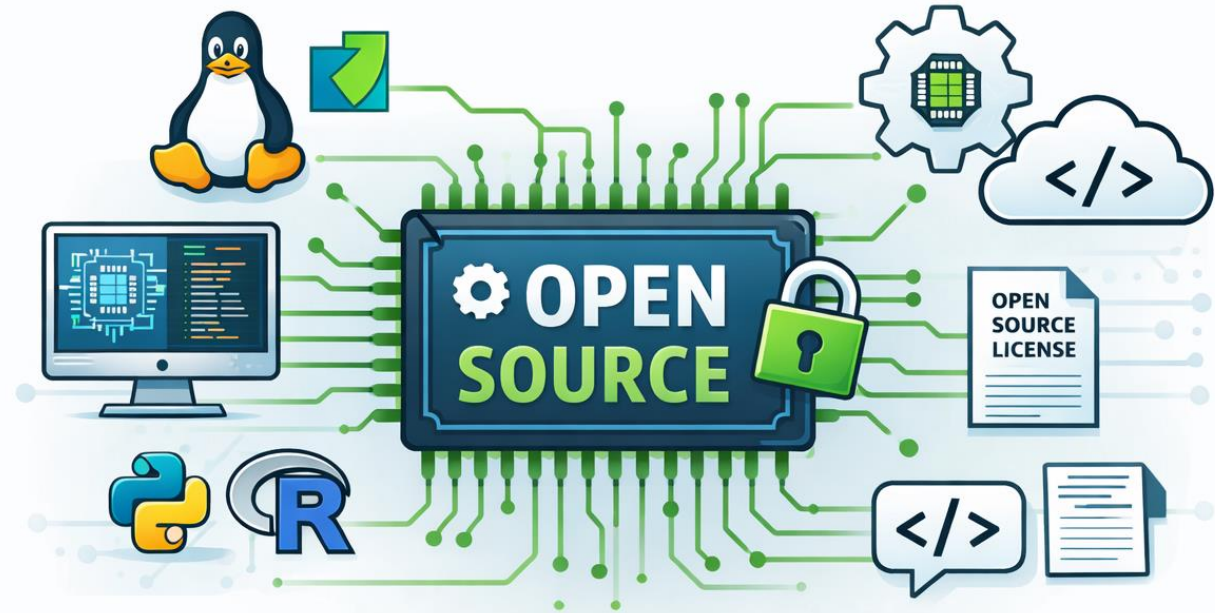
### **Non-invasive battery current measurement and fault prediction/detection System**



# ICELab Selected Projects

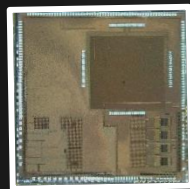
**ODE4EC\_AMS**

ODE4EC\_AMS...

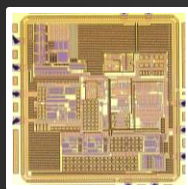


OPEN SOURCE CHIP DESIGN

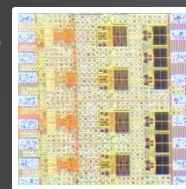
# ICELab Selected Chip Gallery



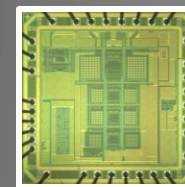
Memristor-based  
Neuromorphic  
Computing  
In 180nm HV-BCD



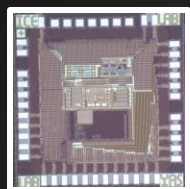
High-Performance  
Operational  
Amplifier  
In 180nm CMOS



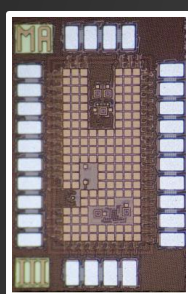
Multi-Channel  
Neural Recording  
Amplifier  
In 180nm CMOS



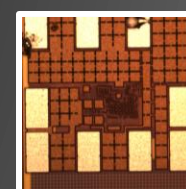
200Hz Bandwidth  
18-bit  $\Delta\Sigma$  ADC  
In 180nm CMOS



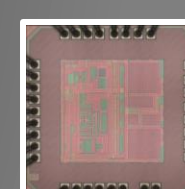
Nano-Oscillator  
Readout Channel  
In 180nm CMOS



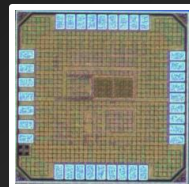
Analog-based  
Spiking Neural  
Network  
In 180nm CMOS



Ultrasonically-  
Powered  
Neural System  
In 180nm CMOS



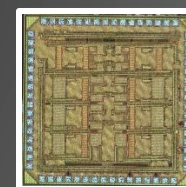
Single Inductor  
Dual Output  
DC/DC Buck  
Converter  
In 65nm CMOS



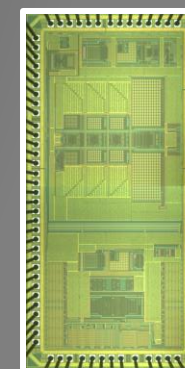
Low-Power  
Temperature  
Sensor  
In 65nm CMOS



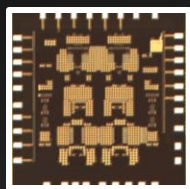
Adaptive  
Spiking Encoder  
In 180nm CMOS



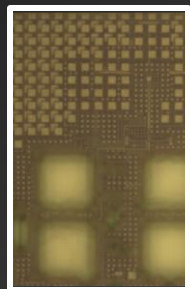
50 MS/s 12-bit  
Analog-to-Digital  
Converter (ADC)  
In 180nm CMOS



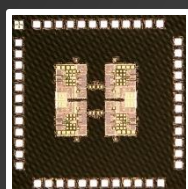
CMOS Interface  
for Spintronic-  
Based Wireless  
Sensor Node  
In 180nm CMOS



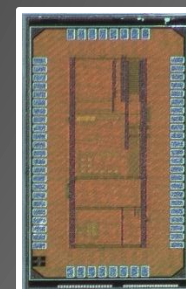
Ear-EEG Signal  
Readout Channel  
In 180nm CMOS



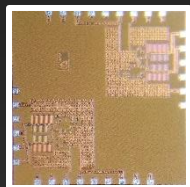
Ultrasonically-  
Powered  
Dust for  
Dual-Wavelength  
Optogenetic  
In 180nm CMOS



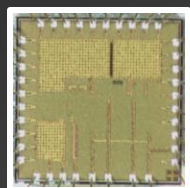
EEG Signal  
Readout Channel  
In 180nm CMOS



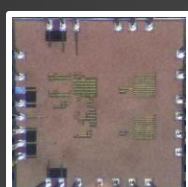
Time-Domain  
Reflectometry  
(TDR)-Based  
Leakage Sensor  
In 65nm CMOS



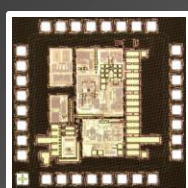
Ultrasonic  
Power and Data  
Transmitter  
In 180nm HV-BCD



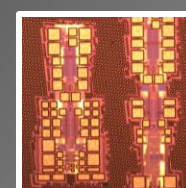
Multi-Core  
Digital-based SNN  
In 28nm CMOS



Arbitrary  
Waveform  
Biphasic  
Neural Stimulator  
In 180nm HV-BCD



Implantable  
Closed-loop  
Neural Stimulator  
In 180nm CMOS



4-Channel  
Chopping  
Neural Amplifier  
In 180nm CMOS

# EDUCATION

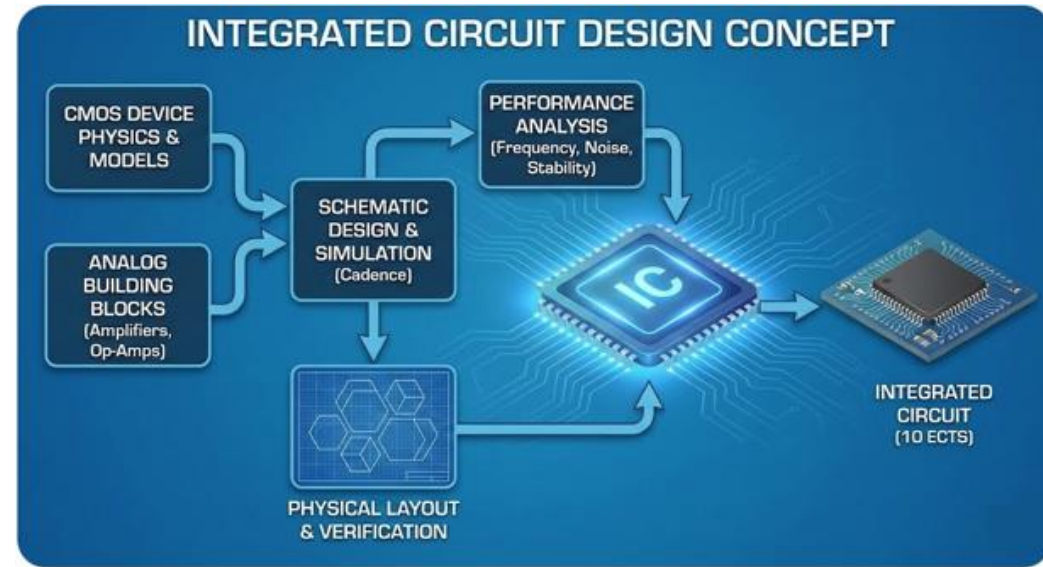
(List of the courses)

<b>Integrated Circuit Design .....</b>	<b>10 ECTS</b>
<b>Analog Circuits and Systems .....</b>	<b>5 ECTS</b>
<b>Data Converters .....</b>	<b>5 ECTS</b>
<b>Neuromorphic Computing .....</b>	<b>5 ECTS</b>
<b>Radio-Frequency Integrated Circuits (RFIC) .....</b>	<b>5 ECTS</b>
<b>Very Large-Scale Integration (VLSI) .....</b>	<b>5 ECTS</b>
<b>Wearable and Implantable Devices .....</b>	<b>5 ECTS</b>

# EDUCATION

## Integrated Circuit Design

10 ECTS



### Aim

- **Core Focus:** Understanding of analog IC design with an emphasis on CMOS
- **Practical Experience:** Hands-on design from the transistor level to layout and post-layout simulations using commercial tools like *Cadence Virtuoso*
- **Approach:** Focuses on intuitive understanding of circuit behavior and practical matters over heavy analytical approaches

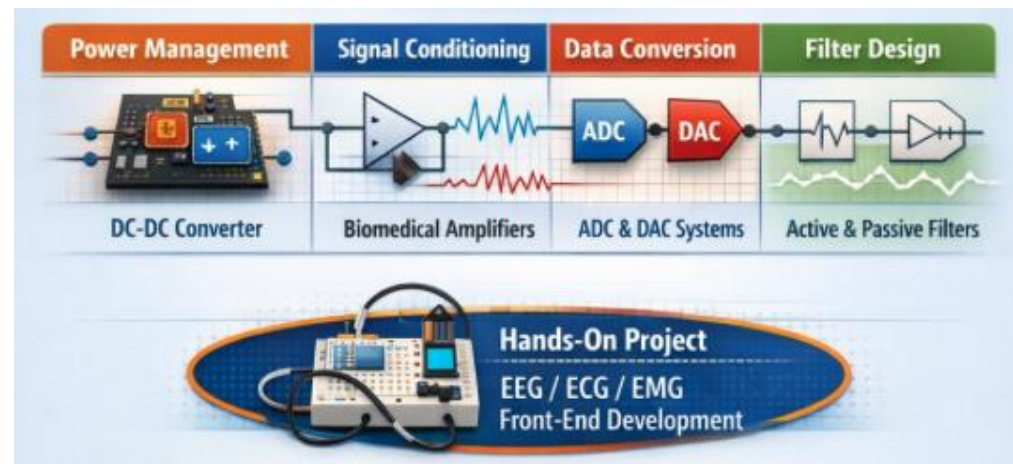
### Covered Topics

- **Foundations:** MOS Device Physics, Models, and Biasing techniques.
- **Amplifiers:** Single-stage, multi-stage, and differential amplifier analysis.
- **Advanced Design:** Op-Amp design, Feedback, and Frequency compensation.
- **Performance:** Noise analysis and mitigating mismatch effects.
- **Physical Implementation:** Design rules, interconnect parasitics, and testing methods.

# EDUCATION

## Analog Circuits and Systems

5 ECTS



### Aim

- **Core Focus:** Develops a foundational understanding of analog circuits, electronic devices, and the critical bridge between the analog and digital worlds
- **System Design:** Provides the essential knowledge required to design new circuits or appropriately integrate existing ones into complex systems
- **Approach:** Translates theoretical concepts into practical implementation through extensive laboratory work and project-based learning

### Covered Topics

- **Power Management:** Design of DC power supplies, including rectifiers, DC-DC converters, and voltage regulators.
- **Precision Amplification:** Exploration of instrumentation amplifier topologies
- **Biomedical Front-Ends:** Practical development of analog front-ends for EEG, ECG, and EMG signal acquisition systems
- **Signal Acquisition:** Mastery of Nyquist sampling theory and fundamental ADC/DAC structures.
- **Filtering:** Implementation of passive, RC, Gm-C, and Switched-Capacitor filters.

# EDUCATION

# Wearable and Implantable Devices

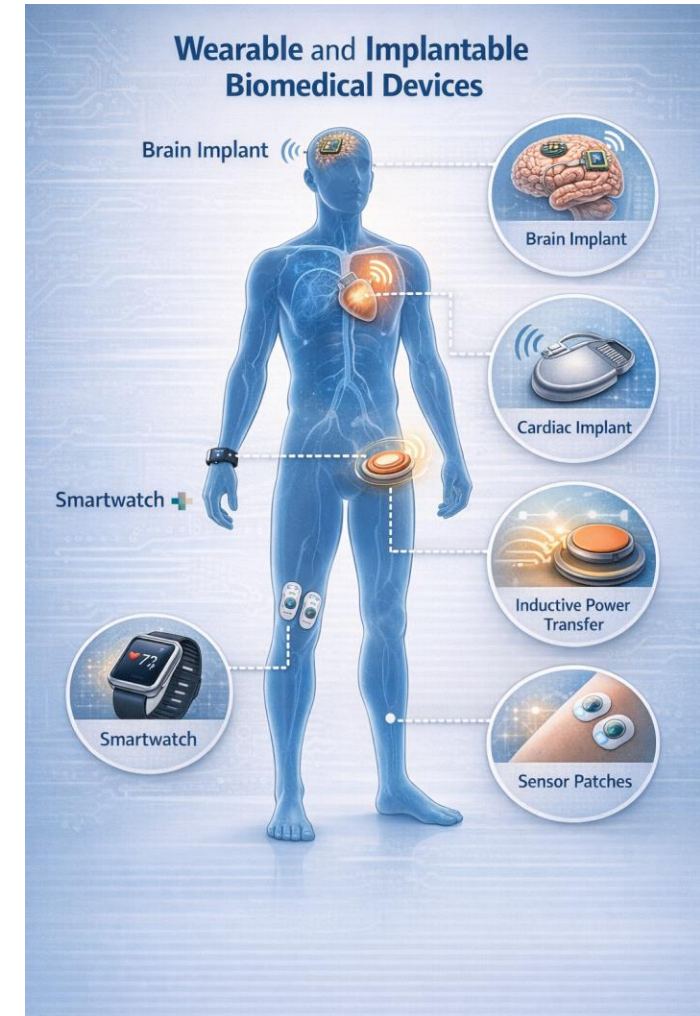
5 ECTS

## Aim

- **Core Focus:** A solid understanding of design principles and challenges of miniaturized wearable and implantable electronic devices
- **Low-Power System:** Enables students to analyze, design, and evaluate biomedical systems that integrate sensing, signal processing, and wireless communication
- **Design Constraints:** Emphasizes strict constraints on power consumption, physical size, and computational complexity

## Covered Topics

- **Biomedical Electronics:** Comprehensive understanding of medical electronics and interfacing with biological tissues.
- **Power Management:** Specialized focus on energy harvesting (thermal, solar, inductive) and low-power techniques from circuit to architecture level
- **Instrumentation:** Techniques for high-precision, low-frequency signal acquisition.
- **Telemetry:** Wireless data & power telemetry techniques for medical devices
- **Case Studies:** Exploration of state-of-the-art technologies, such as brain implants



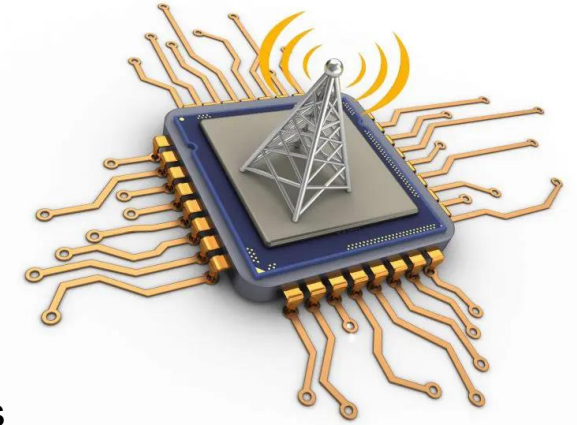
# EDUCATION

## Radio-Frequency Integrated Circuits

10 ECTS

### Aim

- **Core Focus:** Provides fundamental and practical knowledge in designing analog and radio-frequency integrated circuits (RFICs) using modern CMOS technologies
- **System-Level Design:** Students learn to address circuit- and system-level challenges to realize high-performance, low-power RF circuits
- **Practical Applications:** Enables students to apply theoretical principles to the design of complete RF transceiver front-ends for wireless communication systems



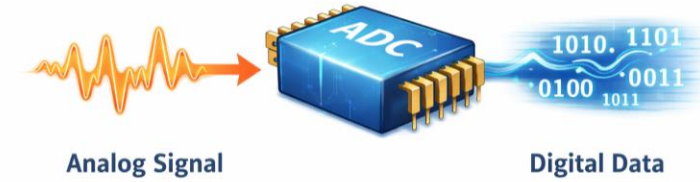
### Covered Topics

- **RF Fundamentals:** Analysis of RF signals, impedance matching, noise, and nonlinearity.
- **Key RF Building Blocks:** Design of Low-Noise Amplifiers (LNAs), Mixers, Oscillators (VCOs), Power Amplifiers (PAs), and Frequency Synthesizers (PLLs)
- **System Architecture:** RF transceiver architectures, system partitioning, and design flow using professional CAD tools (Cadence, ADS, etc.)
- **Advanced Implementation:** Layout considerations, parasitic extraction, and emerging trends in high-frequency IC design

# EDUCATION

## Data Converters

5 ECTS



### Aim

- **Core Focus:** Understanding of data converter design with an emphasis on ADC/DAC architectures
- **Practical Experience:** Hands-on design from the behavioral to transistor level design and simulations using commercial tools like *Matlab* and *Cadence Virtuoso*
- **Approach:** Focuses on intuitive understanding of data converters and practical matters

### Covered Topics

- Fundamentals of data conversion and quantization theory
- Sampling theory, aliasing, and anti-aliasing filter requirements
- Static and dynamic performance metrics (INL/DNL, SNR, ENOB, SFDR, THD)
- Reference circuits and clocking for data converters
- ADC architecture: Flash, SAR, Pipeline, Sigma-Delta, Dual-slope
- DAC architecture: R-2R ladder, Current-steering, Charge-redistribution, Segmented DACs
- Error sources, nonidealities, and practical limitations
- Behavioral modeling using MATLAB/Simulink or similar tools
- Interface considerations for mixed-signal systems
- System-level design trade-offs: speed, resolution, power, area, and noise

# EDUCATION

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## Very- Large-Scale Integrated Circuits (VLSI)

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5 ECTS



### Aim

- **Core Focus:** In-depth understanding of design principles and technological challenges in Very Large-Scale Integration (VLSI)
- **Practical Experience:** ASIC design flow from transistor to layout
- **Approach:** Combined lecture and exercises taking VHDL codes to chip layout on simulation tools and FPGA

### Covered Topics

- Analyze and calculate power consumption in CMOS-based circuits under different conditions.
- Identify and explain the main non-ideal transistor effects and their impact on circuit design.
- Apply design techniques to reduce both static and dynamic power consumption in digital circuits.
- Compare logic families and select suitable implementation methods with respect to power consumption and performance.
- Design and optimize SRAM cells with a focus on low-power consumption.
- Implement and simulate digital neuron models in VHDL, and verify functionality through FPGA-based testing.

# EDUCATION

## Neuromorphic Computing

5 ECTS



### Aim

- **Core Focus:** Introduction to neuromorphic computing, an emerging paradigm that aims to emulate the structure and function of biological neural systems in electronic hardware in digital, analog and using emerging technologies.
- **Practical Experience:** Hands on experience for design and implementation of different neuromorphic computing concepts on software/hardware
- **From Neuroscience to Computing:** Basic understanding of neuroscience approaches, translating them into hardware for the purpose of computing

### Covered Topics

- Apply theoretical concepts of neuromorphic computing to analyze and model neuron and synapse behavior using mathematical and simulation-based approaches.
- Design and simulation of Analog and Digital neuromorphic circuits and architectures for computing purposes
- Evaluate and compare different neuromorphic algorithms and hardware architectures in terms of computational efficiency, energy consumption, and scalability.
- Integrate knowledge of electronics, computing, and materials to assess the trade-offs between CMOS and beyond-CMOS implementations.
- Communicate technical ideas and results related to neuromorphic systems clearly through written reports, presentations, and project demonstrations.

# SDU Micro ICELab

## Our Team



## The Team



**Farshad Moradi**  
Professor  
Section Leader



**Hooman Farkhani**  
Associate Professor  
Deputy Head of Section



**Milad Zamani**  
Associate Professor  
CryoCMOS  
IC Design



**Yasser Rezaeiyan**  
Associate Professor  
Biomedical  
IC Design



**Yarollah Kolivand**  
Senior Chip Designer  
Sensor Interfacing  
IC Design



**Alireza Mosalmani**  
Assistant Professor  
Data Converter  
IC Design



**Margherita Ronchini**  
Postdoc  
IC Design



**Arman Ghouchani**  
PhD Student  
IC Design



**Elham Hatamzadeh**  
Postdoc  
IC Design



**Mads Kofod**  
PhD Student  
Sensor Interface



**Hossein Esmailbeygi**  
Postdoc  
IC Design



**Jens M. Bendtsen H.**  
PhD Student  
IC Design



**Dario F. Khatiboun**  
Postdoc  
Neuromorphic Computing



**Abdul Rehman**  
PhD Student  
IC Design



**Simon N. Richter**  
PhD Student  
Energy efficient ML & Accelerators



**Sajad Eydivandi**  
PhD Student  
State Space Models



**Hoda Fares**  
Assistant Professor  
Neurotechnology (AU)



**Roghayeh Aghazadeh**  
Postdoc  
SNN algorithms for biosignals



**Ravish Kumar Raj**  
Postdoc  
Spintronics for Advanced Computing



**Ali Sahafi**  
Postdoc  
Digital, Mixed/signal IC Design



**Amin Aminifar**  
Postdoc  
ML for Biosignal Processing



**Ming Zhang**  
PhD Student  
Large Language Models



**Peng Weitong**  
PhD Student  
AFE IC design



**Wei-Chieh Ma**  
PhD Student  
Cryogenic CMOS



**Yaogang Wang**  
PhD Student  
AFE IC Design



**Jorge Luis Vega**  
PhD Student  
Neuromorphic Computing

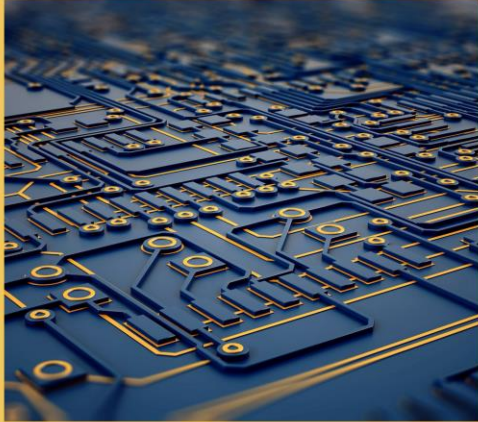


**Jose A. Sanchez Frias**  
PhD Student  
Neuromorphic Computing



**Fattaneh Farhadinia**  
Engineer  
HW Developer

- **Open Assistant Professor** within Photonic Integrated Circuits (Open now)
- **7-8 positions** to be filled by May 2026



## Chips & Dip

Microelectronics Section Event

# Half-day event at SDU on Chip Design

Date: TBA

Location: SDU Microelectronics, Odense

- Pitch talks
- Demonstrations
- Poster Session
- & chips!